# UP05C8GF

# Silicon NPN epitaxial planar type (Tr) Silicon epitaxial planar type (CCD load device)

For CCD output circuits

#### ■ Features

- Two elements incorporated into one package (Tr + CCD load device)
- Downsizing of the equipment and costs can be reduced through reduction of the number of parts

#### ■ Basic Part Number

• 2SC3932 + CCD load device

## ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Tr	Collector-base voltage (Emitter open)	V <sub>CBO</sub>	30	V	
	Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V	
	Emitter-base voltage (Collector open)	V <sub>EBO</sub>	3	V	
	Collector current	$I_{C}$	50	mA	
CCD	Limiting element voltage	V <sub>max</sub>	40	V	
load device	Limiting element current	I <sub>max</sub>	10	mA	
Overall	Total power dissipation *	P <sub>T</sub>	125	mW	
	Junction temperature	T <sub>j</sub>	125	°C	
	Storage temperature	T <sub>stg</sub>	-55 to +125	°C	

Note) \*: Measuring on substrate at 17 mm  $\times$  10 mm  $\times$  1 mm

## ■ Package

• Code

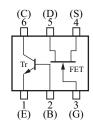
SSMini6-F2

• Pin Name

1: Emitter 4: Source 2: Base 5: Drain 3: Gate 6: Collector

## ■ Marking Symbol: 4V

#### ■ Internal Connection



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UP05C8GF Panasonic

# ■ Electrical Characteristics $T_a = 25$ °C±3°C

## • Tr

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 100 \mu A, I_E = 0$	30			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \mu A, I_C = 0$	3			V
Base-emitter voltage	$V_{BE}$	$V_{CE} = 10 \text{ V}, I_{C} = 2 \text{ mA}$		720		mV
Forward current transfer ratio	h <sub>FE</sub>	$V_{CE} = 10 \text{ V}, I_{C} = 2 \text{ mA}$	100		250	_
Transition frequency *	$f_T$	$V_{CB} = 10 \text{ V}, I_{E} = -15 \text{ mA}, f = 200 \text{ MHz}$		1300		MHz
Power gain	PG	$V_{CB} = 10 \text{ V}, I_{E} = -1 \text{ mA}, f = 100 \text{ MHz}$		20		dB

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

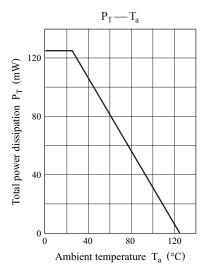
#### • CCD Load Device

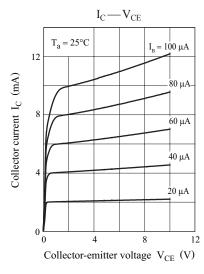
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Pinchi off current	$I_P$	$V_{DS} = 10 \text{ V}, V_G = 0$	3.8		5.2	mA
Output impedance	Z <sub>O</sub>	$V_{DS} = 10 \text{ V}, V_G = 0$		0.05		ΜΩ

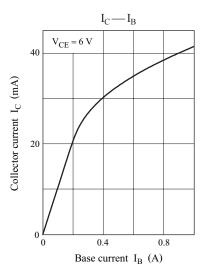
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

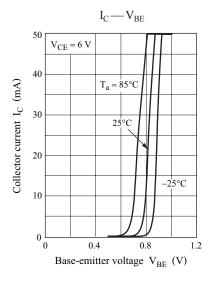
2 SJJ00352BED

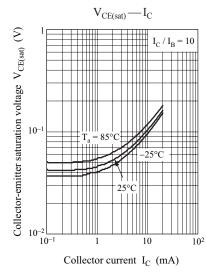
<sup>2. \*:</sup> Pulse measurement

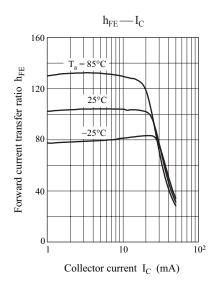


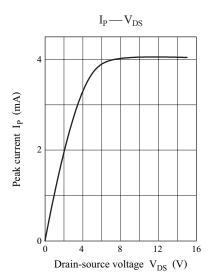








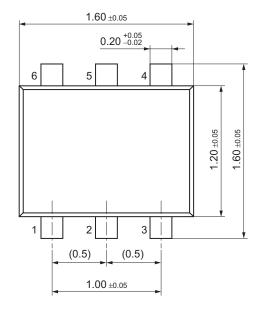


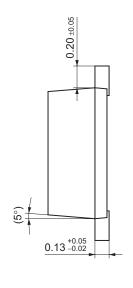


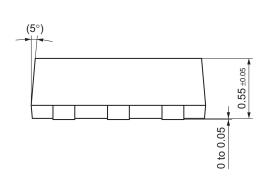
SJJ00352BED 3

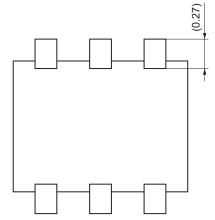
SSMini6-F2

Unit: mm









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